

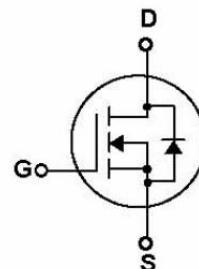
1 Description

These N-Channel enhancement mode power field effect transistors are produced using planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

2 Features

- 600V / 4A
- $R_{DS(on)} = 1.9\Omega(\text{typ})$, $V_{GS} = 10\text{ V}$, $I_D = 2.4\text{ A}$
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability..



3 Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	APQ04SN60CH-XXM0	APQ04SN60CF-XXM0	Units
		APQ04SN60CH-XXJ0	APQ04SN60CF-XXJ0	
		TO-220	TO-220F	
V_{DSS}	Drain-Source Voltage	600		V
I_D	Drain Current - Continuous ($T_C = 25^\circ\text{C}$)	4		A
	- Continuous ($T_C = 100^\circ\text{C}$)	2.5		A
I_{DM}	Drain Current - Pulsed ①	16		A
V_{GS}	Gate-Source Voltage	± 30		V
E_{AS}	Single Pulsed Avalanche Energy ②	260		mJ
I_{AR}	Avalanche Current ①	4		A
E_{AR}	Repetitive Avalanche Energy ①	10		mJ
dv/dt	Peak Diode Recovery dv/dt ③	5		V/ns
P_D	Power Dissipation ($T_C = 25^\circ\text{C}$)	100	33	W
	- De-rate above 25°C	0.8	0.26	$\text{W}/^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +150		$^\circ\text{C}$
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300		$^\circ\text{C}$

* note :

① Repetitive Rating: Pulse width limited by maximum junction temperature.

② $V_{DD}=50\text{V}$, starting $T_J=25^\circ\text{C}$, $L=\text{TBD}$ $R_G=25\Omega$, $I_{AS}=4\text{A}$

③ $I_{SD} \leq 4\text{A}$, $di/dt \leq 100\text{A}/\mu\text{s}$, $V_{DD} \leq V_{(BR)DSS}$, $T_J \leq 150^\circ\text{C}$.



DEVICE SPECIFICATION

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APQ04SN60CF

600V/4A N-Channel MOSFET

4 Thermal Characteristics

Symbol	Parameter	APQ04SN60CH-XXM0	APQ04SN60CF-XXM0	Units
		APQ04SN60CH-XXJ0	APQ04SN60CF-XXJ0	
		TO-220	TO-220F	
R _{θJC}	Thermal Resistance, Junction-to-Case	1.25	3.79	°C/W
R _{θCS}	Thermal Resistance, Case-to-Sink Typ.	0.5	--	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient	62.5	62.5	°C/W

5 Electrical Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	600	--	--	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C	--	0.6	--	V/°C
I _{DSS}	Gate to Source leakage current	V _{DS} = 600 V, V _{GS} = 0 V	--	--	20	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V	--	--	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V	--	--	-100	nA
On Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	2.0	--	4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 2.4 A	--	1.9	2.3	Ω
g _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 2.0 A ④	--	--	15	S
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz	--	575	--	pF
C _{oss}	Output Capacitance		--	67	--	pF
C _{rss}	Reverse Transfer Capacitance		--	12	--	pF
Switching Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{DD} = 300 V, I _D = 4A, R _G = 25 Ω ④	--	11	--	ns
t _r	Turn-On Rise Time		--	36	--	ns
t _{d(off)}	Turn-Off Delay Time		--	46	--	ns
t _f	Turn-Off Fall Time		--	42	--	ns
Q _g	Total Gate Charge	V _{DS} = 480 V, I _D = 4A, V _{GS} = 10 V ④	--	16	--	nC
Q _{gs}	Gate-Source Charge		--	2.9	--	nC
Q _{gd}	Gate-Drain Charge		--	6,3	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I _S	Maximum Continuous Drain-Source Diode Forward Current	--	--	4	A	
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current	--	--	16	A	



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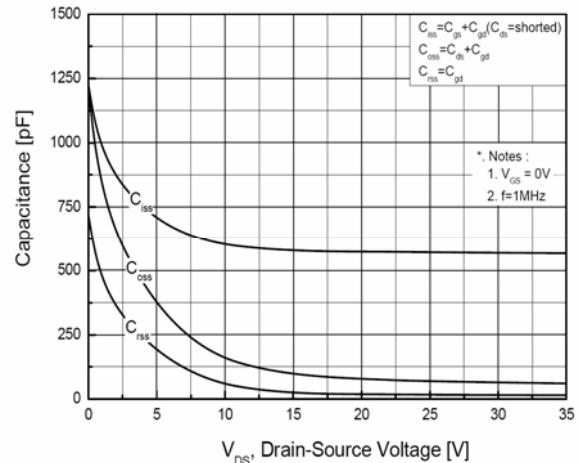
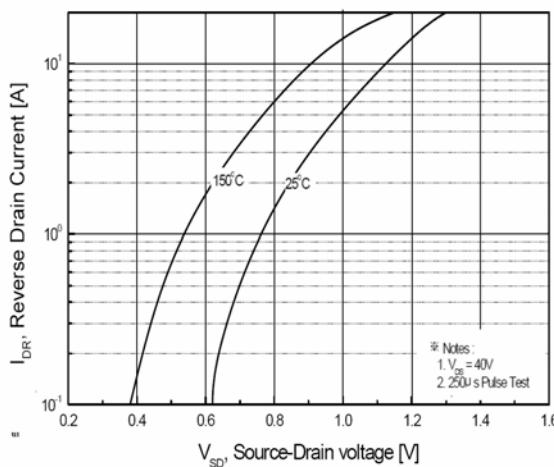
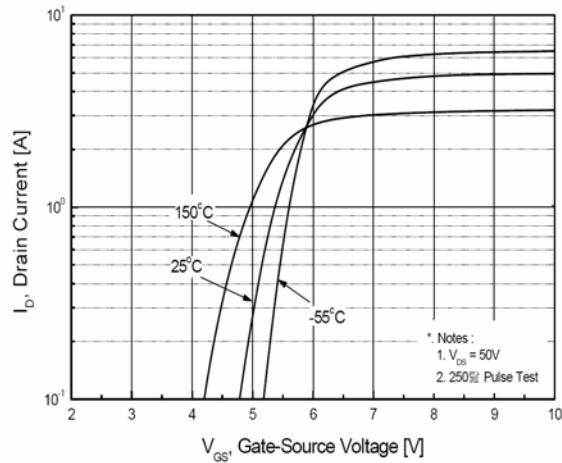
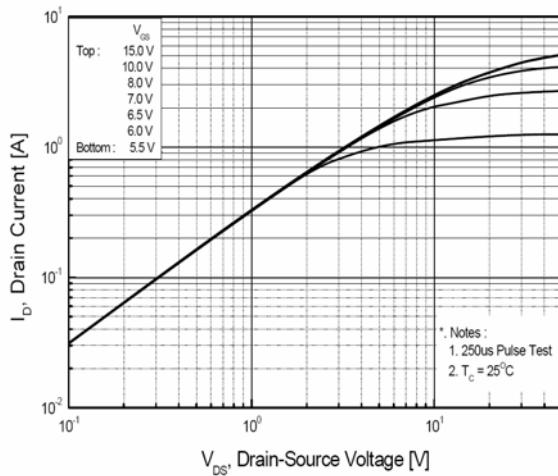
APQ04SN60CH
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600V/4A N-Channel MOSFET

V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 2 \text{ A}$	--	--	1.5	V
t_{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_S = 4 \text{ A}$	--	310	--	ns
Q_{rr}	Reverse Recovery Charge	$dI_F/dt = 100 \text{ A}/\mu\text{s}$ ④	--	2.3	--	μC

Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② VDD=50V, starting TJ=25°C, L=TDB, RG=25Ω, IAS=4A
- ③ ISD ≤ 4A, di/dt ≤ 100A/μs, VDD ≤ V(BR)DSS, TJ ≤ 150°C
- ④ Pulse Test: Pulse width ≤300μs, Duty cycle ≤ 2%. Depend on FT Test.
- ⑤ CP Test

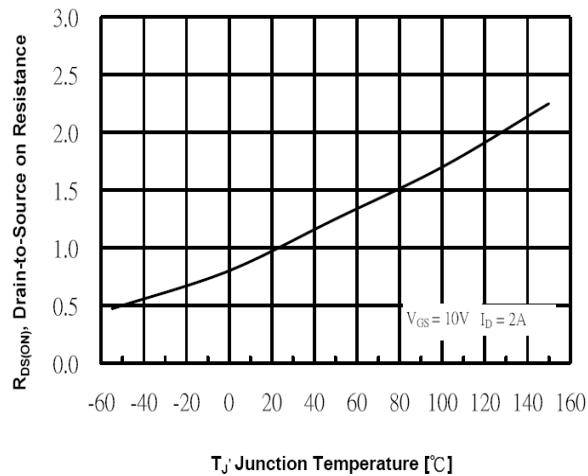
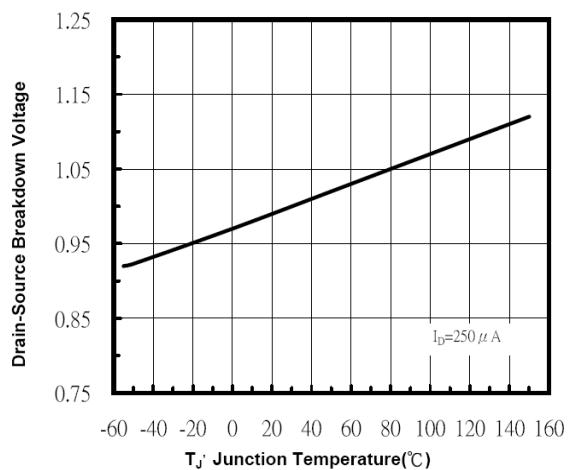
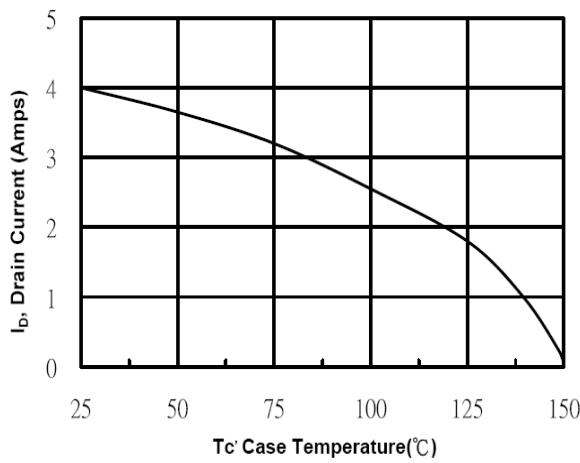
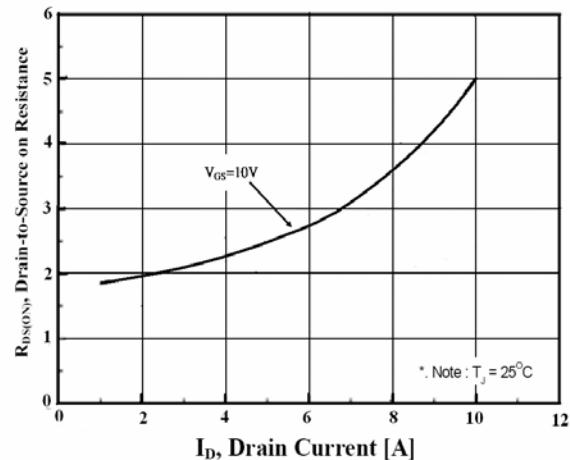
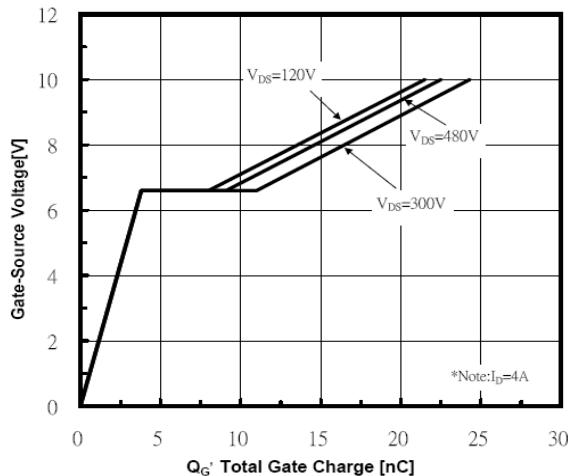




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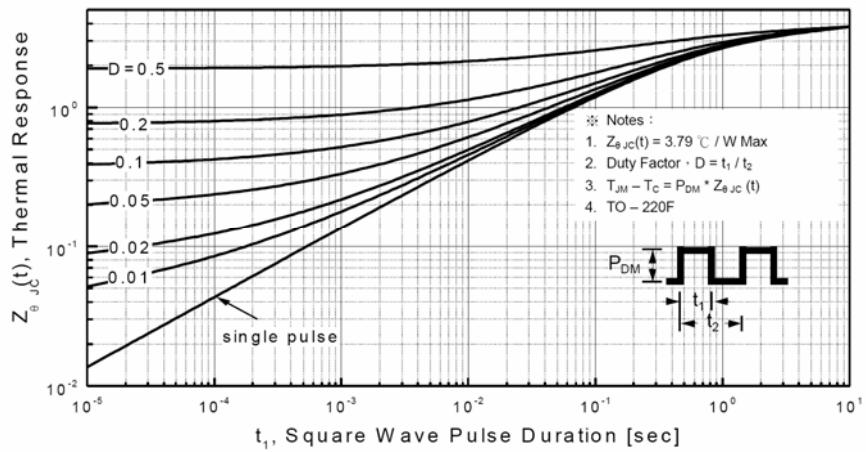
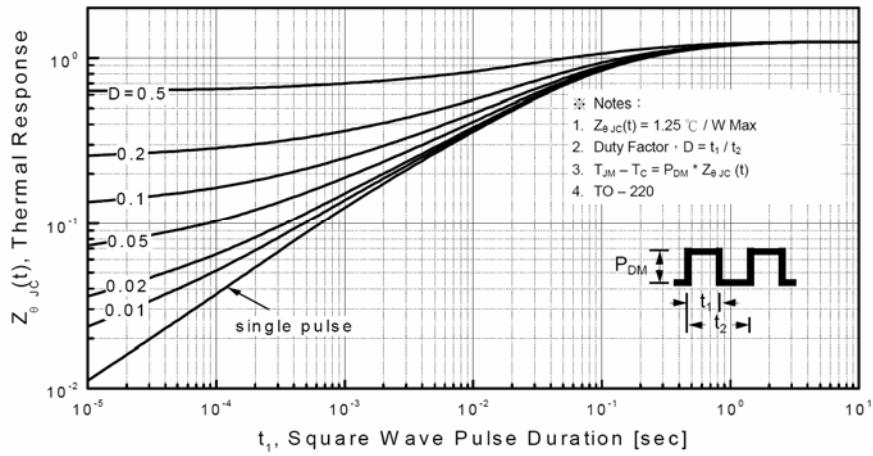
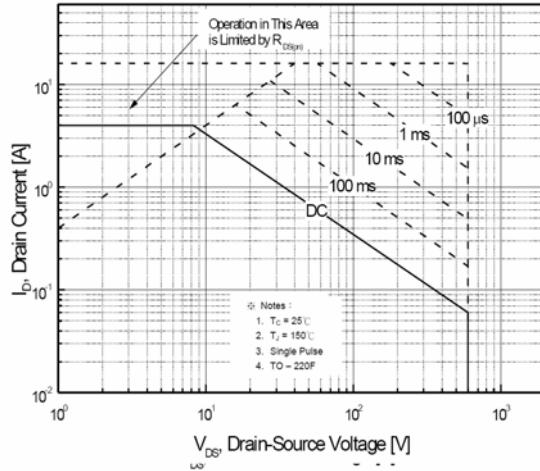
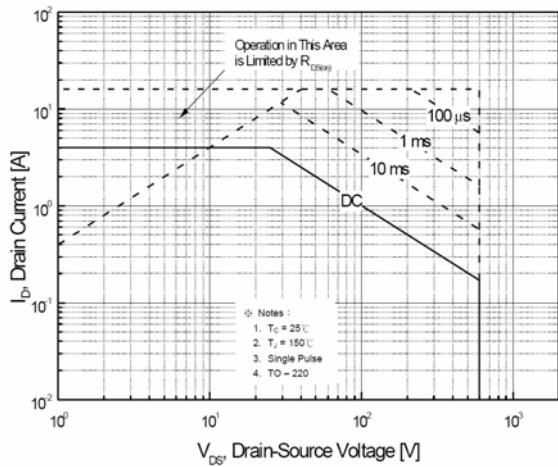




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600V/4A N-Channel MOSFET





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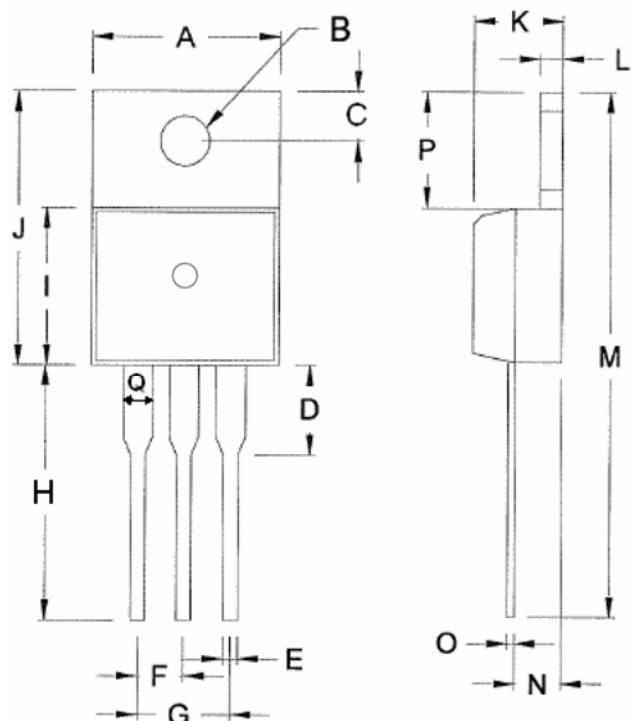
APQ04SN60CH
APQ04SN60CF

600V/4A N-Channel MOSFET

6 Package Dimensions

APQ04SN60CH—XXM0
TO-220

TO-220 DIMENSION			
DIM	MILLIMETERS		
	MIN	MAX	TYP.
A	10.04	10.41	10.23
B	3.66	3.88	3.77
C	2.50	2.84	2.67
D	3.31	4.50	3.91
E	0.70	0.91	0.81
F	2.54(typ.)		2.54
G	5.08(typ.)		5.08
H	13.47	14.20	13.84
I	8.50	9.00	8.80
J	14.80	15.49	15.15
K	4.32	4.57	4.45
L	1.22	1.42	1.30
M	28.27	29.69	28.98
N	2.40	2.90	2.65
O	0.36	0.53	0.45
P	5.97	6.47	6.22
Q	1.15	1.45	1.30





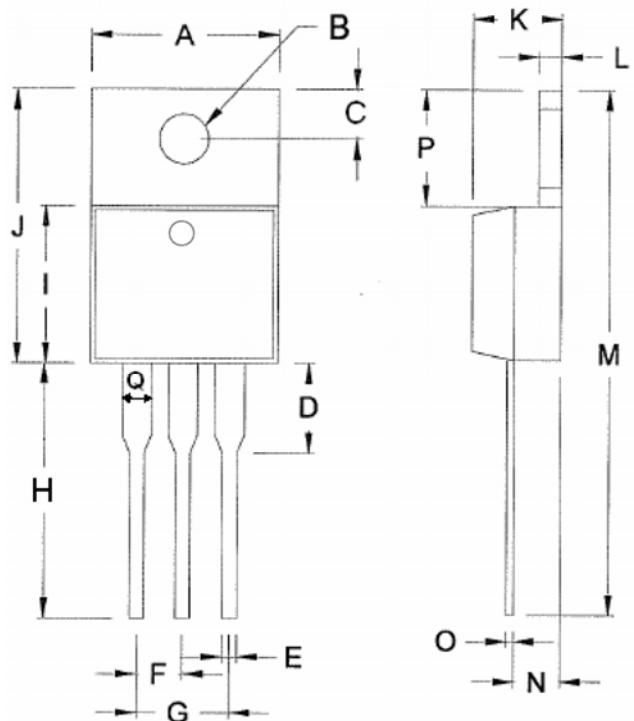
DEVICE SPECIFICATION

APQ04SN60CH
APQ04SN60CF

600V/4A N-Channel MOSFET

APQ04SN60CH—XXJ0
TO-220

TO-220 DIMENSION			
DIM	MILLIMETERS		
	MIN	MAX	TYP.
A	10.01	10.31	10.16
B	3.66	3.94	3.80
C	2.59	2.89	2.74
D	3.5	3.96	3.73
E	0.70	0.90	0.80
F	2.54 TYP.		
G	4.98	5.18	5.08
H	13.4	13.8	13.6
I	8.5	8.9	8.70
J	14.65	15.35	15.05
K	4.47	4.67	4.57
L	1.22	1.42	1.32
M	28.05	29.15	28.60
N	2.52	2.82	2.67
O	0.31	0.53	0.42
P	6.10	6.50	6.30
Q	1.17	1.37	1.27





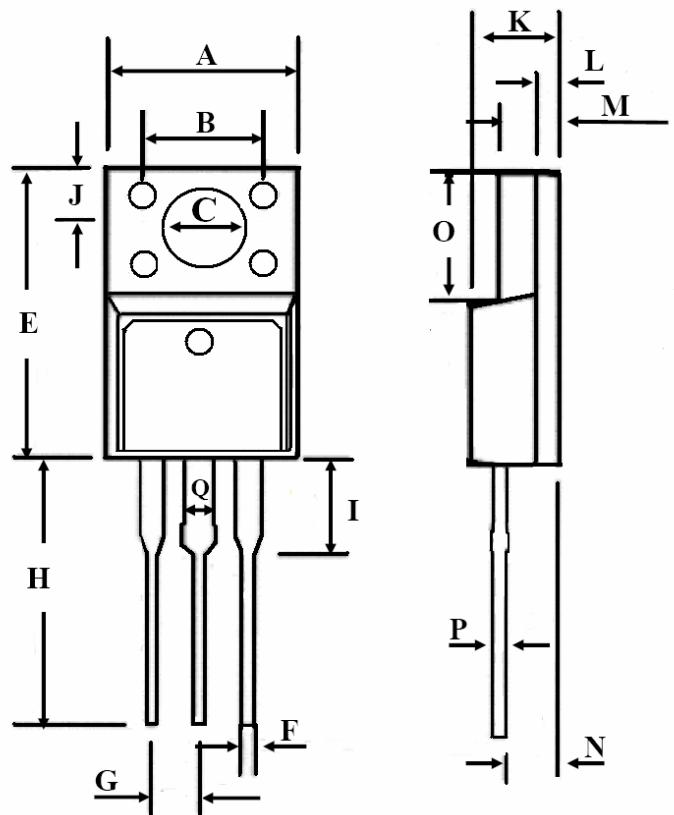
DEVICE SPECIFICATION

APQ04SN60CH
APQ04SN60CF

600V/4A N-Channel MOSFET

APQ04SN60CF-XXM0
TO-220F

TO-220F DIMENSION			
DIM	MILLIMETERS		
	MIN	MAX	TYP.
A	9.96	10.36	10.16
B	6.50 TYP.		6.50
C	3.00	3.20	3.10
E	15.10	16.07	15.59
F	0.55	1.39	0.97
G	2.54 TYP.		
H	12.37	13.5	12.94
I	2.23	3.90	3.07
J	2.90	3.50	3.2
K	4.45	4.93	4.69
L	1.15 TYP.		
M	2.34	2.74	2.54
N	2.56	2.96	2.76
O	6.50	7.10	6.8
P	0.36	0.68	0.52
Q	1.15	1.66	1.41





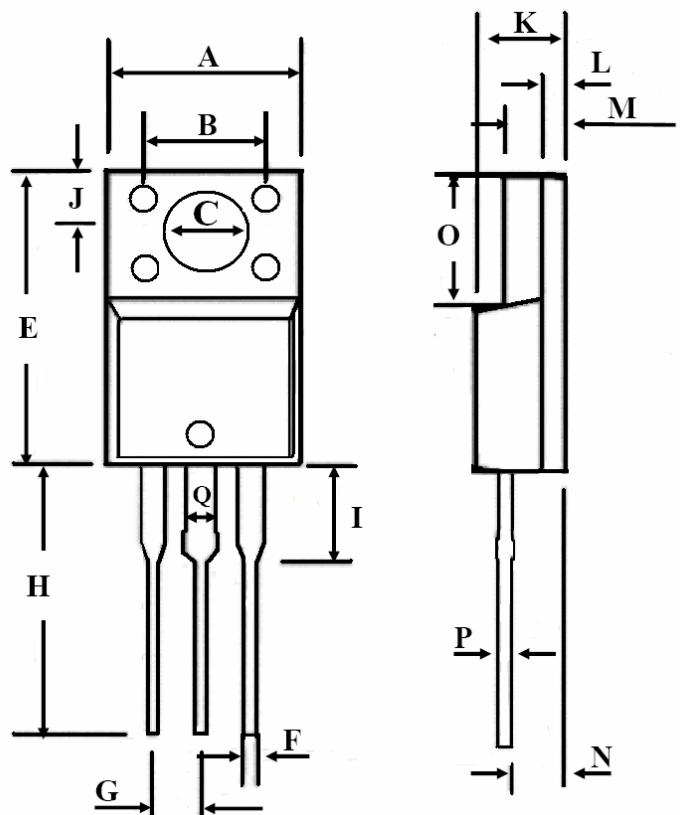
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600V/4A N-Channel MOSFET

APQ04SN60CF-XXJ0
TO-220F

TO-220F DIMENSION			
DIM	MILLIMETERS		
	MIN	MAX	TYP.
A	9.96	10.36	10.16
B	6.50 TYP.		
C	3.5 REF.		
E	14.8	15.2	15.0
F	0.45	0.75	0.55
G	2.54 TYP.		
H	13.23	14.33	13.78
I	3.60	4.00	3.80
J	2.70 TYP.		
K	4.30	4.70	4.50
L	1.30 TYP.		
M	2.80	3.20	3.00
N	2.50	2.90	2.70
O	6.50	7.10	6.8
P	0.45	0.75	0.55
Q	1.05	1.75	1.40





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600V/4A N-Channel MOSFET

Note

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